

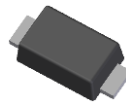
Features

- Low-Forward Voltage Drop
- Low-Leakage Current
- Superior Reverse Avalanche Capability
- Excellent High-Temperature Stability
- Patented Interlocking Clip Design for High-Surge Current Capacity
- Patented Super Barrier Rectifier Technology (SBR®)
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- ±16kV ESD Protection (HBM, 3B)
- ±25kV ESD Protection (IEC61000-4-2 Level 4, Air Discharge)
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.**
<https://www.diodes.com/quality/product-definitions/>
- **An automotive-compliant part is available under separate datasheet (SBR2A40P1Q)**

Mechanical Data

- Package: PowerDI®123
- Package Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (E3)
- Weight: 0.018 grams (Approximate)

PowerDI123



Top View

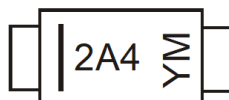
Ordering Information (Notes 4 & 5)

Part Number	Package	Packing	
		Qty.	Carrier
SBR2A40P1-7	PowerDI123	3,000	Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
 5. Product manufactured with data code 0924 (week 24, 2009) and newer are built with green molding compound.

Marking Information

PowerDI123



2A4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: L = 2024)
 M = Month (ex: 9 = September)

Date Code Key

Year	2006	-	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	T	-	L	M	N	P	R	S	T	U	V	W

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (See Figure 1)	I _O	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	50	A
Repetitive Peak Avalanche Power (1 μs, +25°C)	P _{ARM}	6,000	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance	R _{θJS}	5	°C/W
Thermal Resistance Junction to Soldering (Note 6)			
Thermal Resistance Junction to Ambient (Note 7)			
Thermal Resistance Junction to Ambient (Note 8)			
Thermal Resistance Junction to Lead (Note 7)			
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	40	—	—	V	I _R = 100 μA
Forward Voltage Drop	V _F	—	0.265	0.315	V	I _F = 0.1A, T _J = +25°C
		—	0.38	0.43		I _F = 1.0A, T _J = +25°C
		—	0.45	0.50		I _F = 2.0A, T _J = +25°C
		—	0.17	0.22		I _F = 0.1A, T _J = +125°C
		—	0.325	0.375		I _F = 1.0A, T _J = +125°C
		—	0.42	0.47		I _F = 2.0A, T _J = +125°C
Leakage Current (Note 9)	I _R	—	8	40	μA	V _R = 5V, T _J = +25°C
		—	16	100	μA	V _R = 40V, T _J = +25°C
		—	1.3	8	mA	V _R = 5V, T _J = +125°C
		—	2.1	10	mA	V _R = 40V, T _J = +125°C

- Notes:
6. Theoretical R_{θJS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.
 7. FR-4 PCB, 2 oz. copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
 8. Polyimide PCB, 2 oz. copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
 9. Short duration pulse test used to minimize self-heating effect.

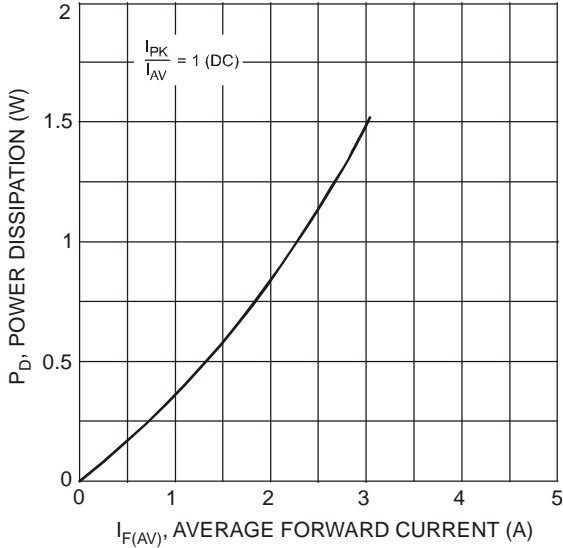


Fig. 1 Forward Power Dissipation

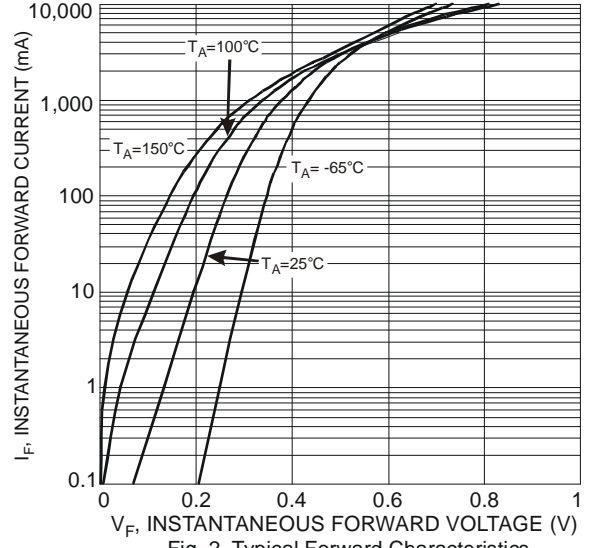


Fig. 2 Typical Forward Characteristics

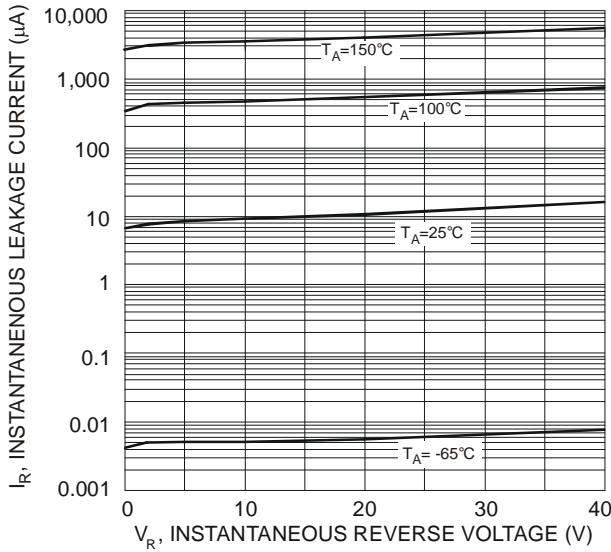


Fig. 3 Typical Reverse Characteristics

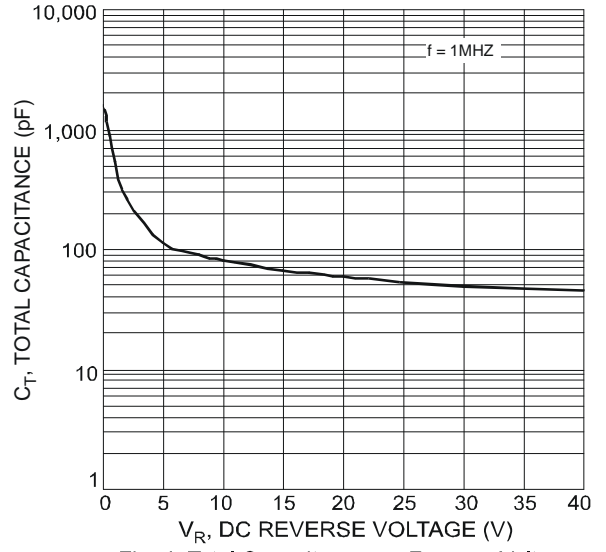


Fig. 4 Total Capacitance vs. Reverse Voltage

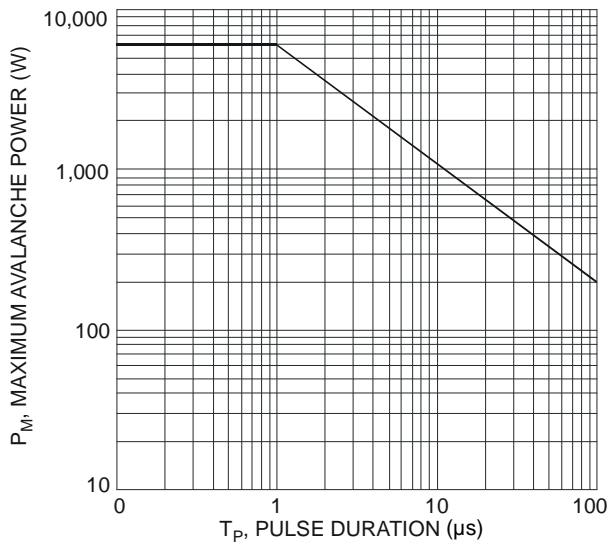


Fig. 5 Maximum Avalanche Power vs. Pulse Duration

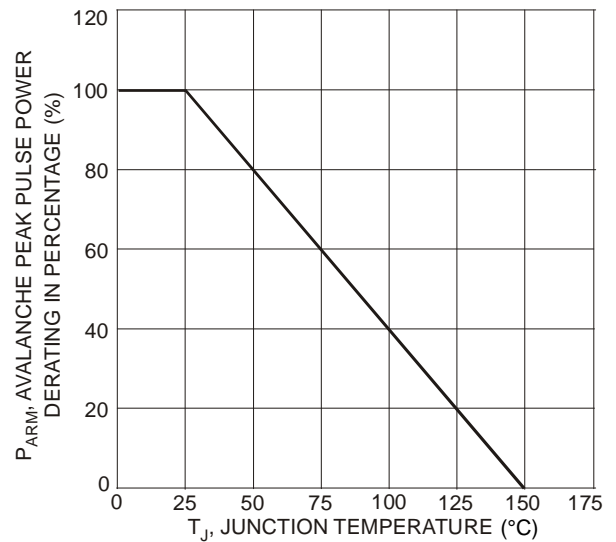


Fig. 6 Pulse Derating Curve

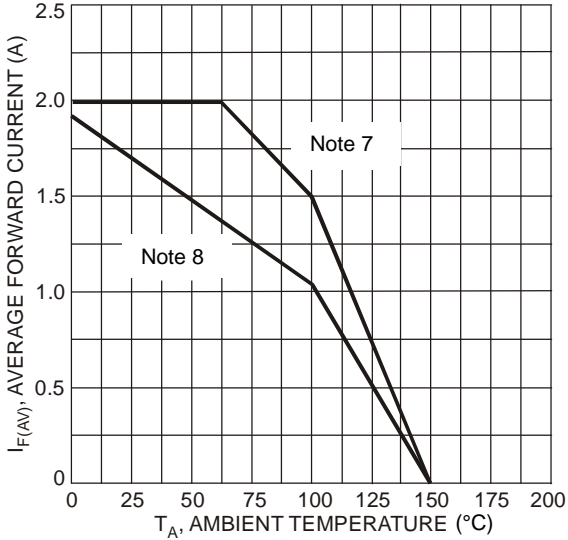


Fig. 7 Forward Current Derating Curve

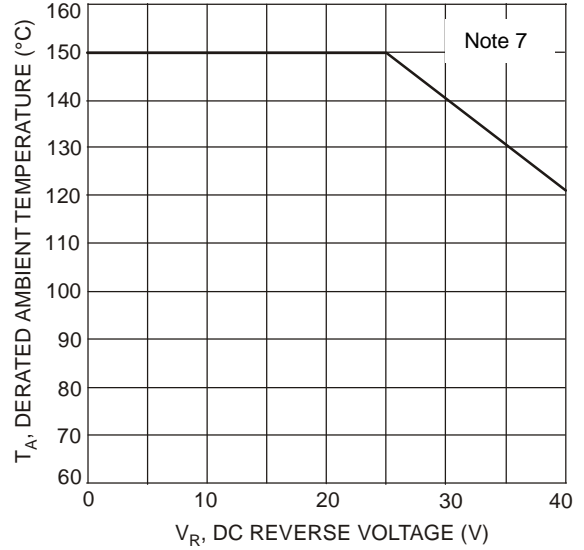


Fig. 8 Operating Temperature Derating

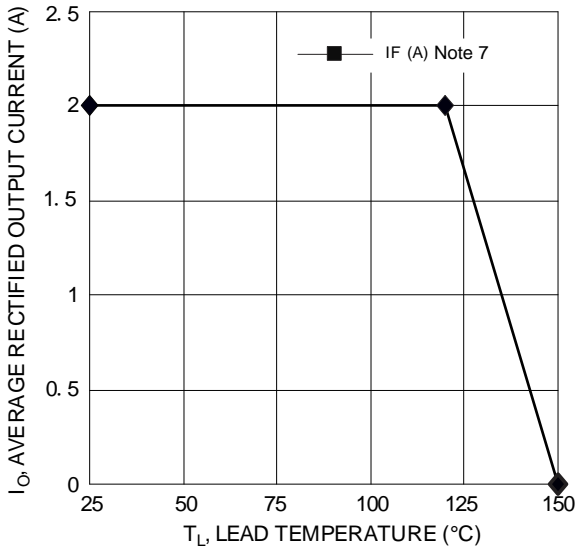


Figure 9 DC Forward Current Derating Curve

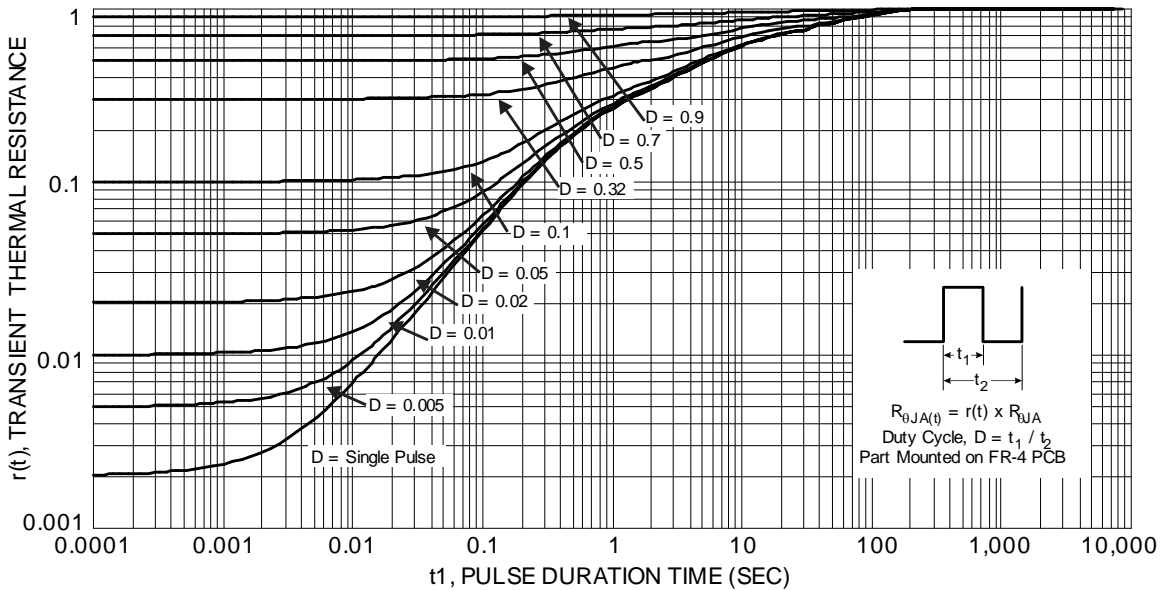
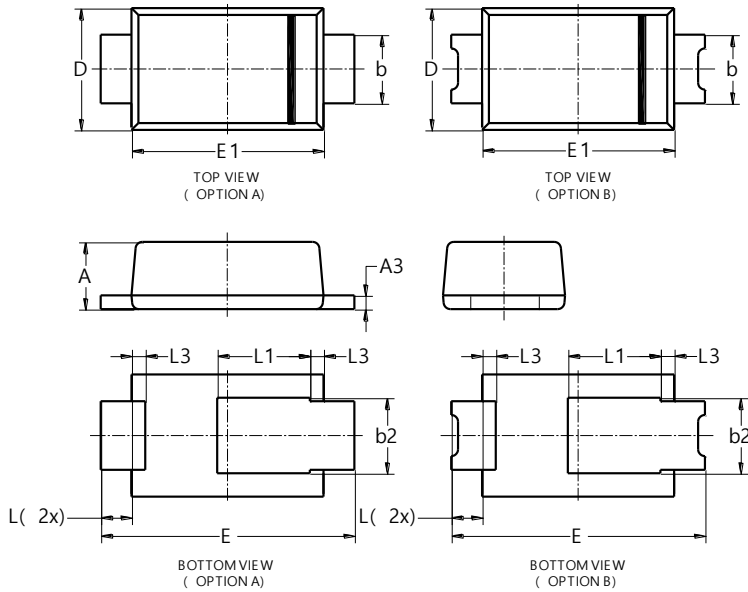


Fig. 10 Transient Thermal Resistance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI123

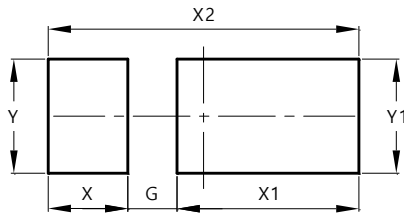


PowerDI123			
Dim	Min	Max	Typ
A	0.93	1.00	0.98
A3	0.15	0.25	0.20
b	0.85	1.25	1.00
b2	1.025	1.125	1.10
D	1.63	1.93	1.78
E	3.50	3.90	3.70
E1	2.60	3.00	2.80
L	0.40	0.50	0.45
L1	1.25	1.40	1.35
L3	0.125	0.275	0.20
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI123



Dimensions	Value (in mm)
G	0.65
X	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50

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